

**SUPPLEMENT NO. 7 TO PART 748 - AUTHORIZATION VALIDATED END-USER (VEU): LIST OF VALIDATED END-USERS, RESPECTIVE ITEMS ELIGIBLE FOR EXPORT, REEXPORT AND TRANSFER, AND ELIGIBLE DESTINATIONS**

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 748.15(c).				
<b>China (People's Republic of)</b>	Advanced Micro Devices China, Inc.	3D002, 3D003, 3E001 (limited to "technology" for items classified under 3C002 and 3C004 and "technology" for use during the International Technology Roadmap for Semiconductors (ITRS) process for items classified under ECCNs 3B001 and 3B002), 3E002 (limited to "technology" for use during the ITRS process for items classified under ECCNs 3B001 and 3B002), 3E003.e (limited to the "development" and "production" of integrated circuits for commercial applications), 4D001, 4D002 and 4E001 (limited to the "development" of products under ECCN 4A003).	AMD Technologies (China) Co., Ltd., No. 88, Su Tong Road, Suzhou, China 215021.	75 FR 25763, 5/10/10.
			Advanced Micro Devices (Shanghai) Co., Ltd. Buildings 46, 47, 48 & 49, River Front Harbor, Zhangjiang Hi-Tech Park 1387 Zhangdong Rd., Pudong, Shanghai, China 201203.	76 FR 2802, 1/18/11.
			AMD Technology Development (Beijing) Co., Ltd. North and South Buildings RaycomInfotech, Park Tower C, No. 2 Science Institute South Rd., Zhong Guan Cun, Haidian District, Beijing, China 100190.	78 FR 3319, 1/16/13.
			AMD Products (China) Co. Ltd. North and South Buildings RaycomInfotech Park Tower C, No. 2 Science Institute South Rd., Zhong Guan Cun, Haidian District, Beijing, China 100190.	

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	Advanced Micro-Fabrication Equipment, Inc., China	2B230, 3B001.c and 3B001.e (items classified under ECCNs 3B001.c and 3B001.e are limited to components and accessories).	Advanced Micro-Fabrication Equipment, Inc., China 188 Taihua Road Jinqiao Export Processing Zone (South Area) Pudong, Shanghai 201201, China.	78 FR 41291, 7/10/13.
	Applied Materials (China), Inc.	<i>These Items Authorized for those Applied Materials Destinations Identified by one asterisk (*):</i> 2B006.b, 2B230, 2B350.g.3, 2B350.i, 3B001.a, 3B001.b, 3B001.c, 3B001.e, 3B001.f, 3C001, 3C002, 3D002 (limited to “software” specially designed for the “use” of stored program controlled items classified under ECCN 3B001).	<p>*Applied Materials South East Asia Pte. Ltd. Shanghai Depot c/o Shanghai Applied Materials Technical Service Center No. 2667 Zuchongzhi Road, Shanghai, China 201203.</p> <p>*Applied Materials South East Asia Pte. Ltd. Beijing Depot c/o Beijing Applied Materials Technical Service Center No. 1 North Di Sheng Street, BDA Beijing, China 100176.</p> <p>*Applied Materials South East Asia Pte. Ltd. Wuxi Depot c/o Sinotrans Jiangsu Fuchang Logistics Co., Ltd. 1 Xi Qin Road, Wuxi Export Processing Zone Wuxi, Jiangsu, China 214028.</p>	72 FR 59164, 10/19/07. 74 FR 19382, 4/29/09. 75 FR 27185, 5/14/10. 77 FR 10953, 2/24/12.

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		<p><i>These Items Authorized for the Applied Materials Destination Identified by two asterisks (**):</i>            2B006.b, 2B230, 2B350.g.3, 2B350.i, 3B001.a, 3B001.b, 3B001.c, 3B001.e, 3B001.f, 3C001, 3C002, 3D002 (limited to “software” specially designed for the “use” of stored program controlled items classified under ECCN 3B001), and 3E001 (limited to “technology” according to the General Technology Note for the “development” or “production” of items controlled by ECCN 3B001).</p>	<p>*Applied Materials South East Asia Pte. Ltd. Wuhan Depot            c/o Wuhan Optics Valley Import &amp; Export Co., Ltd.            No. 101 Guanggu Road            East Lake High-Tec Development Zone            Wuhan, Hubei, China 430074.</p> <p>*Applied Materials (China), Inc. Shanghai Depot            No. 2667, Zuchongzhi Road            Shanghai, China 201203.</p> <p>*Applied Materials (China), Inc. Beijing Depot            No. 1 North Di Sheng Street, BDA            Beijing, China 100176.</p> <p>**Applied Materials (Xi’an) Ltd.            No. 28 Xin Xi Ave., Xi’an High Tech Park            Export Processing Zone            Xi’an, Shaanxi, China 710075.</p>	

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	Boeing Tianjin Composites Co. Ltd.	1B001.f, 1D001 (limited to “software” specially designed or modified for the “use” of equipment controlled by 1B001.f), 2B001.b.2 (limited to machine tools with accuracies no better than ( <i>i.e.</i> , not less than) 13 microns), 2D001 (limited to “software,” other than that controlled by 2D002, specially designed or modified for the “use” of equipment controlled by 2B001.b.2), and 2D002 (limited to “software” for electronic devices, even when residing in an electronic device or system, enabling such devices or systems to function as a “numerical control” unit, capable of coordinating simultaneously more than 4 axes for “contouring control” controlled by 2B001.b.2).	Boeing Tianjin Composites Co. Ltd. No. 4-388 Heibei Road Tanggu Tianjin, China.	72 FR 59164, 10/19/07. 74 FR 19382, 4/29/09. 77FR 10953, 2/24/12. 77 FR 40258, 7/9/12.
	CSMC Technologies Corporation	1C350.c.3, 1C350.c.11, 2B230.a, 2B230.b, 2B350.f, 2B350.g, 2B350.h, 3B001.e 3B001.h (except for multilayer masks with a phase shift layer designed to produce “space qualified” semiconductor devices), 3C002.a, and 3C004.	<p>CSMC Technologies Fab 1 Co., Ltd. 14 Liangxi Road Wuxi, Jiangsu 214061, China.</p> <p>CSMC Technologies Fab 2 Co., Ltd. 8 Xinzhou Rd. Wuxi National New Hi-Tech Industrial Development Zone Wuxi, Jiangsu 214028, China.</p>	76 FR 2802, 1/18/11. 76 FR 37634, 6/28/11. 77 FR 10953, 2/24/12. 78 FR 23472, 4/19/13. 78 FR 32981, 6/3/13.

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	Intel Semiconductor (Dalian) Ltd.	<p><i>These items authorized for the Intel destination identified by one asterisk (*):</i></p> <p>1A004, 1C006.d, 2A226, 2A292, 2B006.b, 2B230, 2B231, 2B350, 3A233.a, 3B001 (except for multilayer masks with a phase shift layer designed to produce “space qualified” semiconductor devices), 3C002, 3E002 (excluding “development” and “production” technology specific to digital signal processors and digital array processors and further limited to “technology” based on the international technology roadmap for semiconductors (ITRS)), and 4E001(limited to “technology” for computer products or components not exceeding an adjusted peak performance (APP) level of 12.0 weighted teraflops).</p>	<p>*Intel Semiconductor (Dalian) Ltd. No. 109 Huai He Road East Dalian Economic and Technology Development Area Dalian, Liao Ning Province, 116600 China</p>	78 FR 54752, 9/6/13.
		<p><i>These items authorized for the Intel destination identified by two asterisks (**):</i></p> <p>1A004, 1C006.d, 2A226, 2A292, 2B006.b, 2B230, 2B231, 2B350, 3A233.a, 3B001 (except for multilayer masks with a phase shift layer designed to produce “space qualified”</p>	<p>** Intel Semiconductor (Dalian) Ltd. c/o Dalian Kintetsu Logistics Co., Ltd Dayaowan Bonded Port No. 6 Road W4 Unit A1 Dalian Economic and Technology Development Area Dalian, Liao Ning Province, 116601 China</p>	

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	Lam Research Service Co., Ltd.	semiconductor devices), and 3C002.  <i>These Items Authorized for those Lam's Destinations Identified by a single asterisk (*):</i> 2B230, 2B350.c, 2B350.d, 2B350.g, 2B350.h, 2B350.i, 3B001.c and 3B001.e (items classified under ECCNs 3B001.c and 3B001.e are limited to “specially designed” components and accessories), 3D001 (limited to “software” (excluding source code) “specially designed” for the “development” or “production” of equipment controlled by ECCN 3B001), 3D002 (limited to “software” (excluding source code) “specially designed” for the “use” of equipment controlled by ECCN 3B001), and 3E001 (limited to “technology” according to the General Technology Note for the “development” of equipment controlled by ECCN 3B001).	*Lam Research International Sarl (Lam Shanghai Warehouse) c/o HMG Supply Chain (Shanghai) Co., Ltd. No. 3869, Longdong Avenue Pudong New District Shanghai, China 201203.  *Lam Research International Sarl (Lam Shanghai Warehouse; WGQ Bonded Warehouse) c/o HMG Supply Chain (Shanghai) Co., Ltd. No. 55, Fei la Road, Waigaoqiao Free Trade Zone Pudong New Area Shanghai, China 200131.  *Lam Research International Sarl (Lam Beijing Warehouse) c/o Beijing Lam Electronics Tech Center 1 Building, No. 28, Jinghai Second Road, BDA Beijing, China 100176.  *Lam Research International Sarl (Wuxi EPZ Bonded Warehouse) c/o HMG WHL Logistic (Wuxi) Co., Ltd. 1st Fl, Area 4, No. 1, Plot J3 No. 5 Gaolang East Road Export Processing Zone Wuxi, China 214028.	75 FR 62462, 10/12/10. 77 FR 10953, 2/24/12. 78 FR 3319, 1/16/13. 78 FR 54752, 9/6/13. 79 FR 71014, 12/1/14.

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			<p>*Lam Research International Sarl (Lam Beijing Warehouse) c/o HMG Hi-tech Logistics (Beijing) Co., Ltd. Building 3, No. 9 Ke Chuang Er Street Beijing Economic Technological Development Area Beijing, China 100176.</p> <p>*Lam Research International Sarl (Wuhan TSS) c/o HMG Wuhan Logistic Co., Ltd. 1<sup>st</sup>-2<sup>nd</sup> Floor, Area B, No. 5 Building Hua Shi Yuan Er Road East-lake Hi-Tech Development Zone Wuhan, Hubei Province, China 430223.</p> <p>*Lam Research International Sarl (Lam Shanghai Warehouse Operator) c/o Shanghai Well-win Logistics Co., Ltd No. 2667 Zuchongzhi Road Pudong New District Shanghai, China.</p> <p>*Lam Research International Sarl (Lam Beijing Warehouse) c/o China International Electronic Service Company 1 Building, No. 28, Jinghai Second Road, BDA Beijing, China 100176.</p>	

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			<p>*Lam Research International Sarl (Lam Beijing Warehouse) c/o Beijing STE International Logistics Co., Ltd. Building 3, No. 9 Ke Chuang Er Street Beijing Economic &amp; Technological Development Area Beijing, China 100176.</p> <p>* Lam Research International Sarl (Lam Dalian Warehouse) c/o JD Logistics Dalian bonded logistic Co., Ltd. No.1 Public Warehouse Dalian Bonded Logistics Zone Dalian, China 116600.</p> <p>* Lam Research International Sarl (Lam Xi'an Warehouse) c/o VR International Logistics (Xi'an) Co., Ltd. No.28 Information Road, EPZ B Zone, Xian New District Xian, China 710119.</p> <p>* Lam Research International Sarl (Wuxi Bonded Warehouse for CIQ inspection) c/o SinoTrans Jiangsu Fuchang Logistics Co., Ltd. No.1 Xiqin Road, Area A, Export Processing Zone, New District</p>	



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		<p><i>These Items Authorized for those Lam's Destinations Identified by two asterisks (**):</i>            2B230, 2B350.c, 2B350.d, 2B350.g, 2B350.h, 2B350.i, 3B001.c and 3B001.e (items classified under ECCNs 3B001.c and 3B001.e are limited to "specially designed" components and accessories), 3D001 (limited to "software" (excluding source code) "specially designed" for the "development" or "production" of equipment controlled by ECCN 3B001), 3D002 (limited to "software" (excluding source code) "specially designed" for the "use" of equipment controlled by ECCN 3B001), and 3E001 (limited to "technology" according to the General Technology Note for the "development" or "production" (limited to those stages that support integration, assembly (mounting), inspection, testing, and quality assurance) of equipment</p>	<p>Wuxi, China 214028.</p> <p>**Lam Research Service Co., Ltd.            1st Floor, Area C            Hua Hong Science &amp; Technology Park            177 Bi Bo Road            Zhangjiang Hi-Tech Park            Pudong, Shanghai, China 201203.</p> <p>**Lam Research Service Co., Ltd. Beijing Branch            6th Floor, Building 52,            No.2, Jingyuan North Street,            Beijing Economic &amp; Technological Development Area            Beijing, China 100176.</p> <p>**Lam Research Service Co., Ltd.            Wuxi Representative Office            Room 302, Building 6, Singapore International Park            No. 89 Xing Chuang Si Road            Wuxi New District.            Wuxi, Jiangsu, China 214028.</p> <p>**Lam Research Service Co., Ltd.            Wuhan Representative Office            Room 302, Guanggu Software Park,</p>	

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		controlled by ECCN 3B001).	<p>Building E4 No. 1 Guanshan Road Donghu Development Zone Wuhan, Hubei Province, China 430074.</p> <p>**Lam Research Service Co., Ltd. (Lam Dalian Representative Office) c/o Intel Semiconductor (Dalian) Ltd. No. 109 Huaihe Road East, Dalian Economic &amp; Technical Development Area Dalian, China, 116600.</p> <p>**Lam Research Service (Shanghai) Co., Ltd. Xi'an Branch Room 602, Building G, Wangzuo Xiandai City 35 Tangyan Road, Gaoxin District, Xi'an, China, 710065.</p>	
	Samsung China Semiconductor Co. Ltd.	1C350.c.3, 1C350.d.7, 2B230, 2B350.d.2, 2B350.g.3, 2B350.i.3, 3A233, 3B001.a.1, 3B001.b, 3B001.c, 3B001.e, 3B001.f, 3B001.h, 3C002, 3C004, 3D002, and 3E001 (limited to "technology" for items classified under 3C002 and 3C004 and "technology" for use consistent with the International Technology Roadmap for Semiconductors process for items classified under ECCNs 3B001 and 3B002).	Samsung China Semiconductor Co. Ltd. No.1999, North Xiaohe Road Xi'an, China 710119.	78 FR 41291, 7/10/13. 78 FR 69535, 11/20/13. 79 FR 30713, 5/29/14

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	Semiconductor Manufacturing International Corporation	1C350.c.3, 1C350.d.7, 2B006.b.1, 2B230, 2B350.d.2, 2B350.d.3, 2B350.g.3, 2B350.i.3, 3A233, 3B001.a, 3B001.b, 3B001.c, 3B001.e, 3B001.f, 3C001, 3C002, 3C003, 3C004, 5B002, and 5E002 (limited to “technology” according to the General Technology Note for the “production” of integrated circuits controlled by ECCN 5A002 that have been classified by BIS as eligible for License Exception ENC under paragraph (b)(2) or (b)(3) of Section 740.17 of the EAR, or classified by BIS as a mass market item under paragraph (b)(3) of Section 742.15 of the EAR).	<p>Semiconductor Manufacturing International (Shanghai) Corporation 18 Zhang Jiang Rd., Pudong New Area Shanghai, China 201203.</p> <p>Semiconductor Manufacturing International (Tianjin) Corporation 19 Xing Hua Avenue Xi Qing Economic Development Area Tianjin, China 300385.</p> <p>Semiconductor Manufacturing International (Beijing) Corporation, No. 18 Wen Chang Road Beijing Economic-Technological Development Area Beijing, China 100176.</p> <p>Semiconductor Manufacturing International (Shenzhen) Corporation Qier Road, Export Processing Zone Pingshan New Area, Shenzhen, China 518118.</p> <p>Semiconductor Manufacturing North China (Beijing) Corporation No. 18 Wen Chang Road, Building 9 Beijing Economic-Technological Development Area Beijing, China 100176.</p>	<p>72 FR 59164, 10/19/07. 75 FR 67029, 11/1/10. 77 FR 10953, 2/24/12. 78 FR 69535, 11/20/13. 79 FR 30713, 5/29/14. 79 FR 34221, 6/16/14.</p>
	Shanghai Huahong Grace	1C350.c.3, 1C350.d.7, 2B230, 2B350.d.2, 2B350.g.3, 2B350.i.4, 3B001.a.1, 3B001.b, 3B001.c, 3B001.e,	Shanghai Huahong Grace Semiconductor Manufacturing Corporation – HFab 2 668 Guoshoujing Road	78 FR 32981, 6/3/13.

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	Semiconductor Manufacturing Corporation	3B001.f , 3B001.h, 3C002, 3C004, 5B002, and 5E002 (limited to production technology for integrated circuits controlled by ECCNs 5A002 or 5A992 that have been successfully reviewed under the encryption review process specified in Sections 740.17(b)(2) or 740.17(b)(3) and 742.15 of the EAR).	<p>Zhangjiang Hi-Tech Park Shanghai 201203 China.</p> <p>Shanghai Huahong Grace Semiconductor Manufacturing Corporation – HFab 1 1188 Chuanqiao Road Pudong, Shanghai 201206 China.</p> <p>Shanghai Huahong Grace Semiconductor Manufacturing Corporation – GFab1 1399 Zuchongzhi Road Zhangjiang Hi-Tech Park Shanghai 201203 China.</p>	
	SK hynix Semiconductor (China) Ltd.	3B001.a, 3B001.b, 3B001.c, 3B001.e, and 3B001.f.	SK hynix Semiconductor (China) Ltd. Lot K7, Wuxi High-tech Zone Comprehensive Bonded Zone Wuxi New District, Jiangsu Province, China 214028.	75 FR 62462, 10/12/10. 77 FR 40258, 7/9/12. 78 FR 3319, 1/16/13. 78 FR 69535, 11/20/13
	SK hynix Semiconductor (Wuxi) Ltd.	3B001.a, 3B001.b, 3B001.c, 3B001.e, and 3B001.f.	SK hynix Semiconductor (Wuxi) Ltd., Lot K7-1, Wuxi High-tech Zone Comprehensive Bonded Zone Wuxi New District, Jiangsu Province, China 214028.	75 FR 62462, 10/12/10. 77 FR 40258, 7/9/12. 78 FR 3319, 1/16/13. 78 FR 69535, 11/20/13

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<b>India</b>	GE India Industrial Pvt Ltd.	1C002.a.1, 1C002.a.2, 1C002.b.1.a, 1C002.b.1.b, 1E001, 2E003.f, 9E003.a.1, 9E003.a.2, 9E003.a.4, 9E003.a.5, 9E003.a.6, 9E003.a.8, and 9E003.c.	<p>GE India Technology Centre Private Limited (GEITC) No. 122, EPIP, Phase II Hoodi Village, Whitefield Road Bangalore 560066, Karnataka, India.</p> <p>Bangalore Engineering Center (BEC) c/o GE India Technology Centre Private Limited (GEITC) No. 122, EPIP, Phase II Hoodi Village, Whitefield Road Bangalore 560066, Karnataka, India.</p>	<p>74 FR 31620, 7/2/09.</p> <p>74 FR 68147, 12/23/09.</p> <p>77 FR 10953, 2/24/12.</p>